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(54) **BIO-SENSING INTEGRATED GARMENT**

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A61B 5/01 (2006.01)

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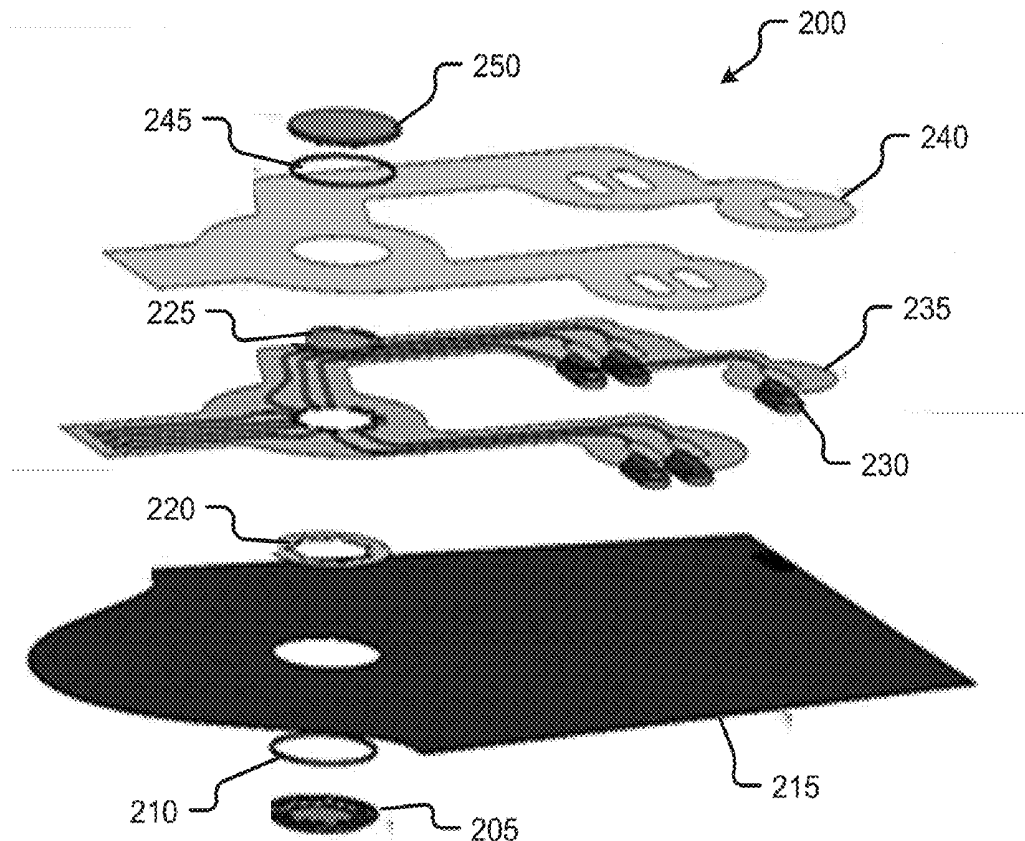
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(57)

ABSTRACT

Embodiments of the disclosure provide systems and methods for a garment comprising a fabric layer, a plurality of biometric sensors integrated into the fabric layer, and a connectivity layer integrated into the fabric layer. The connectivity layer can comprise signal conductors and power conductors coupled with each of the plurality of biometric sensors. The garment can further comprise a power source coupled with each of the power conductors and providing, via the power conductors of the connectivity layer, electrical power to each of the plurality of biometric sensors, a signal monitor coupled with the connectivity layer and receiving, via the signal conductors of the connectivity layer, a signal comprising biometric information from each of the plurality of biometric sensors, and a gateway coupled with the signal monitor, the gateway receiving the biometric information from the signal monitor and providing the biometric information to an external computer system.



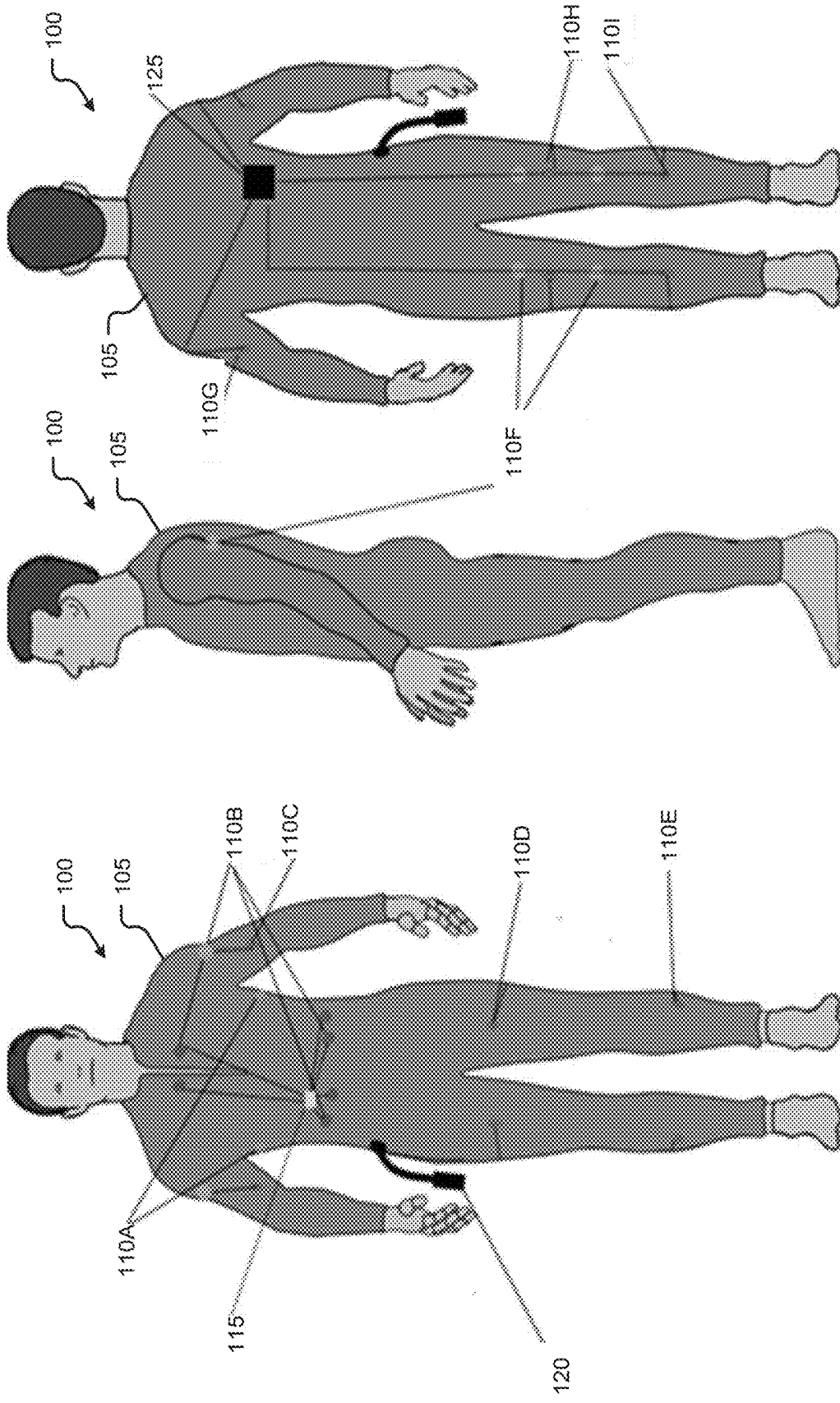


Fig. 1C

Fig. 1B

Fig. 1A

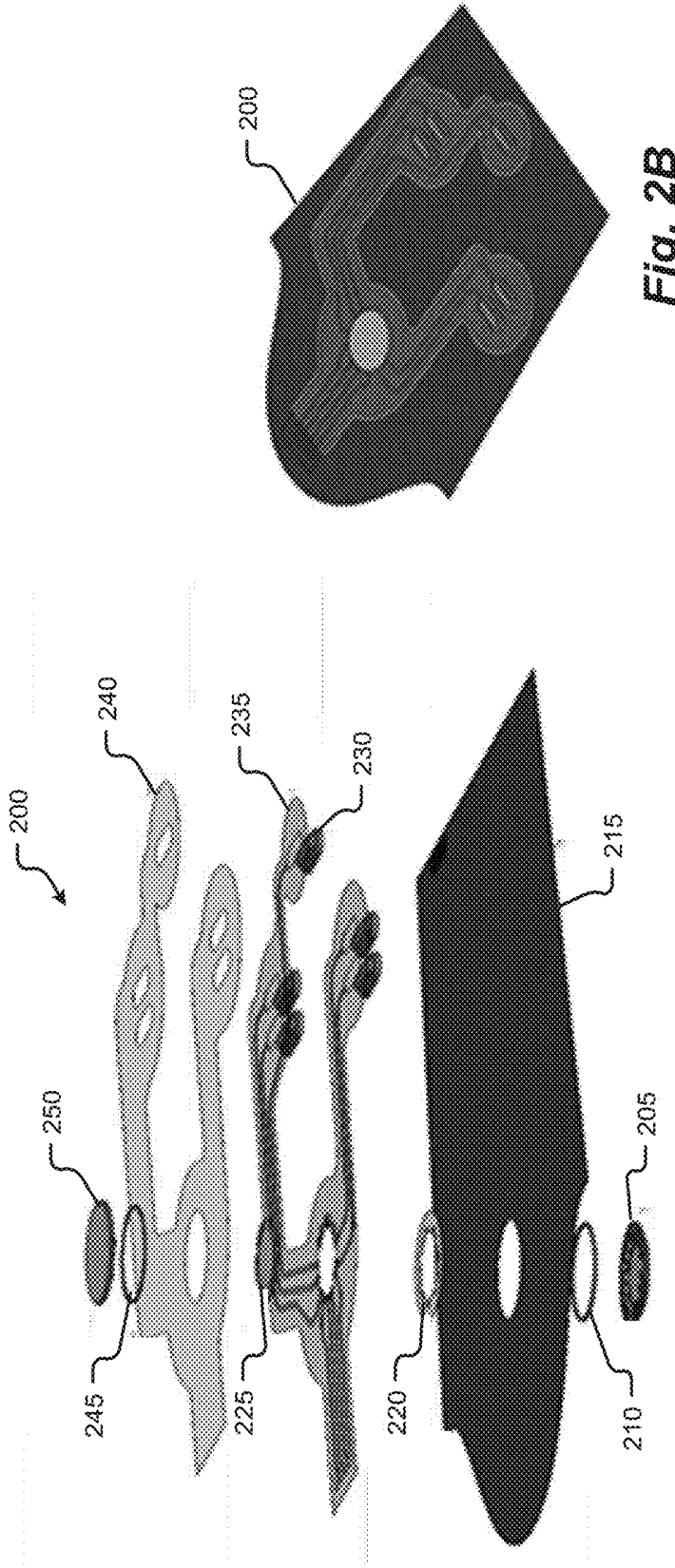


Fig. 2A

Fig. 2B

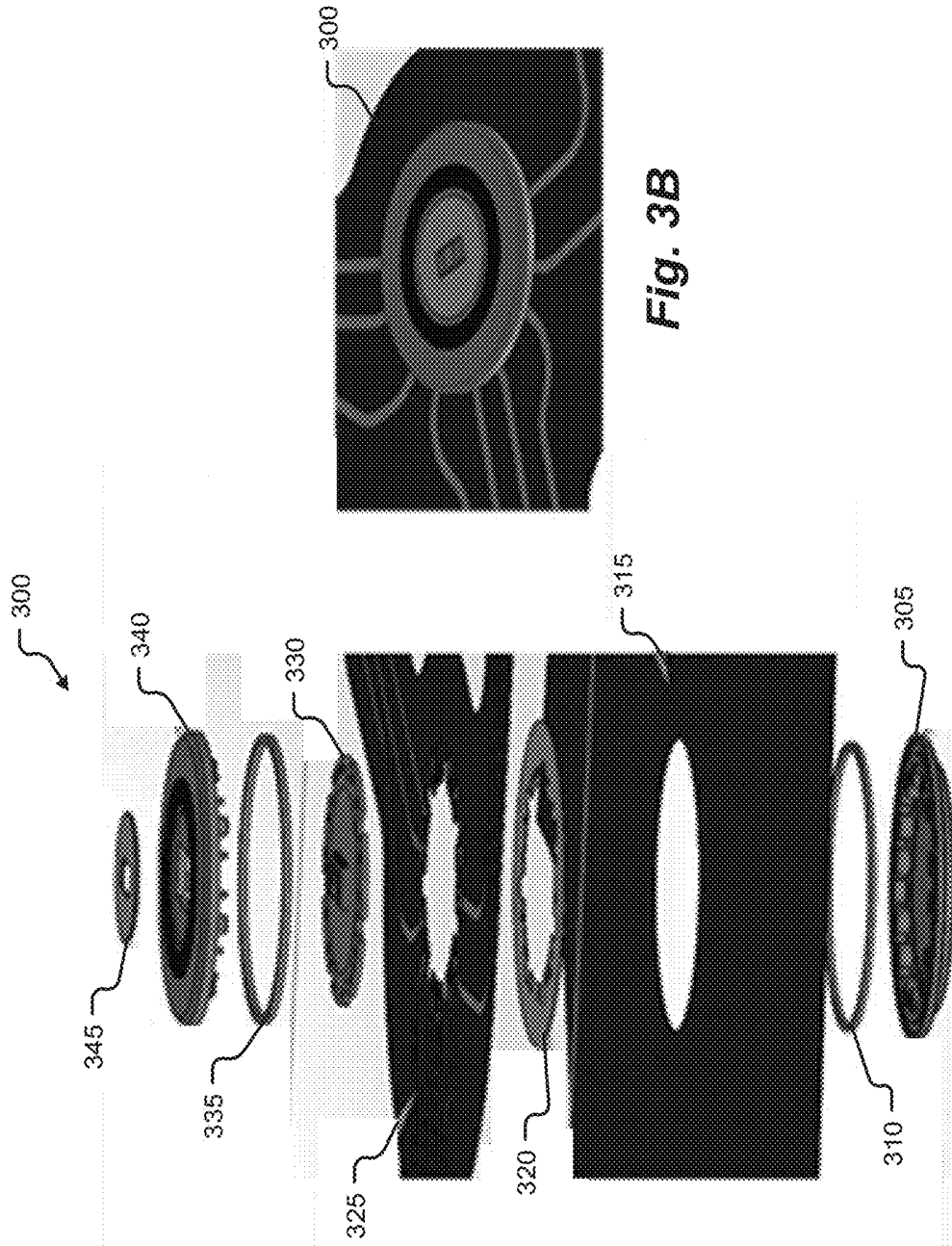


Fig. 3A

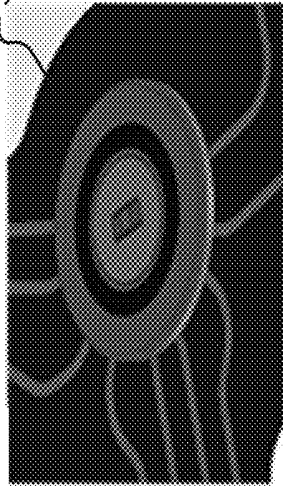


Fig. 3B

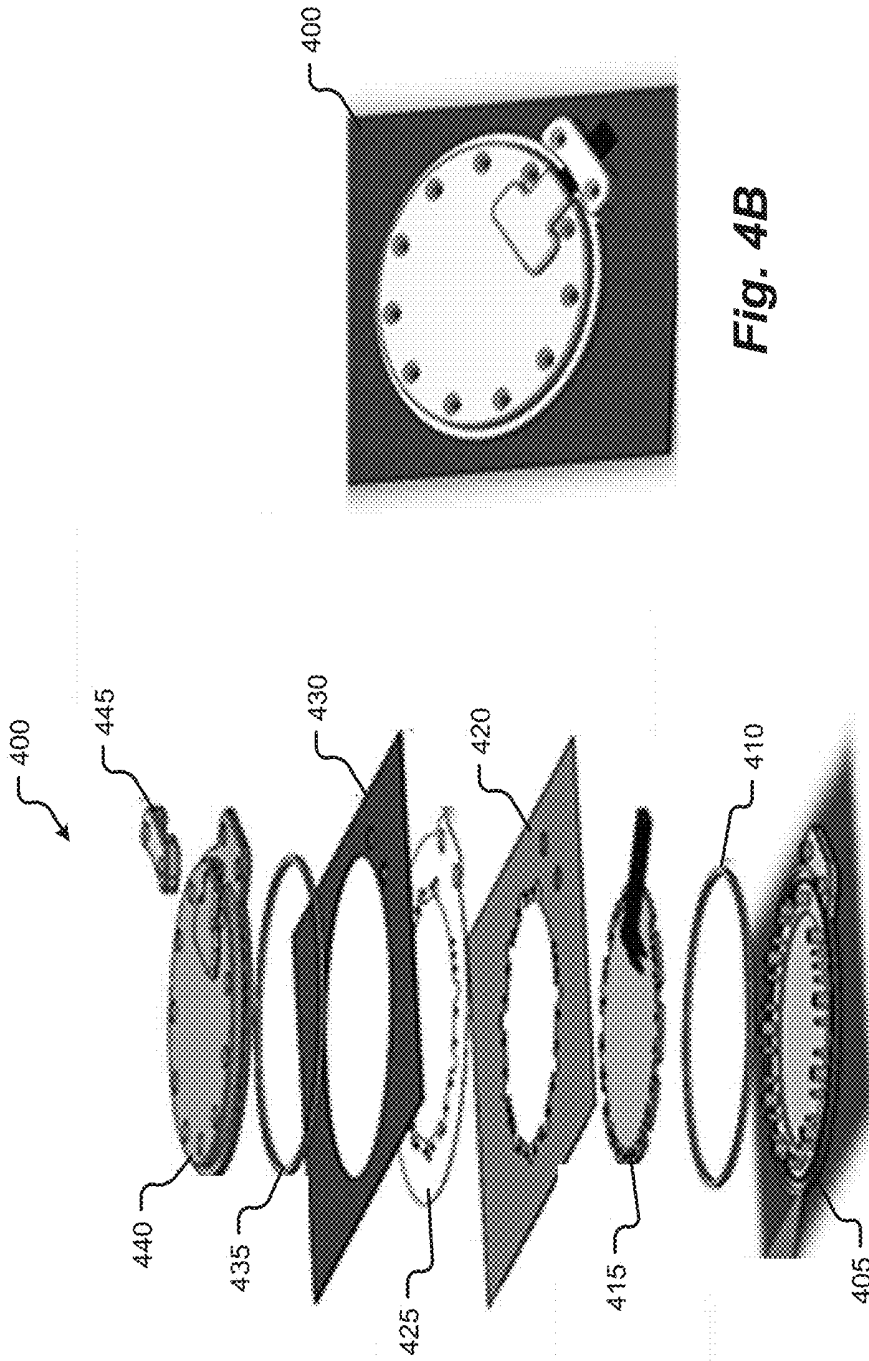


Fig. 4B

Fig. 4A

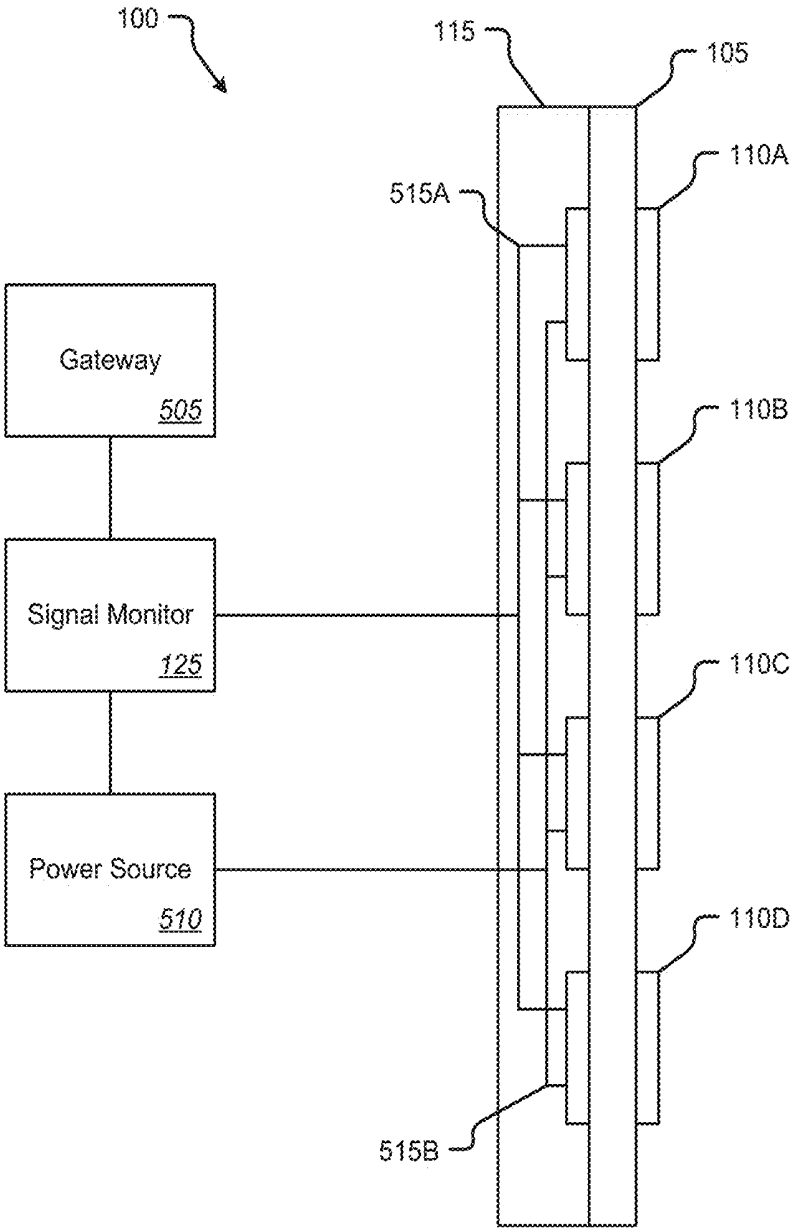


Fig. 5

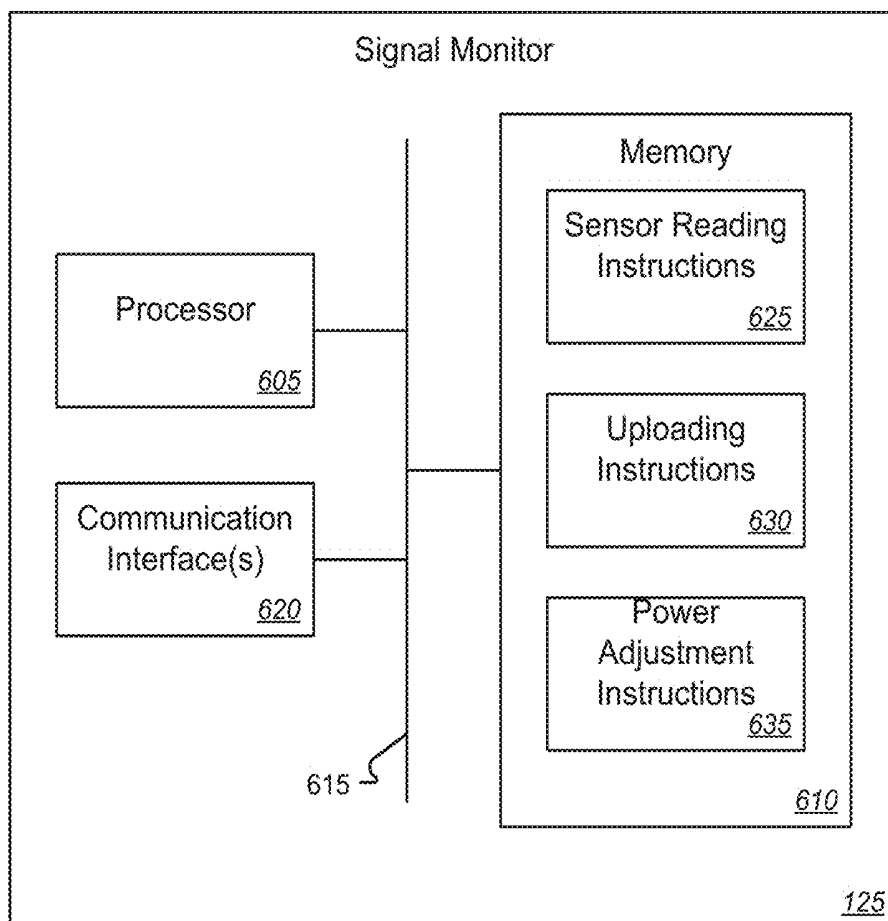


Fig. 6

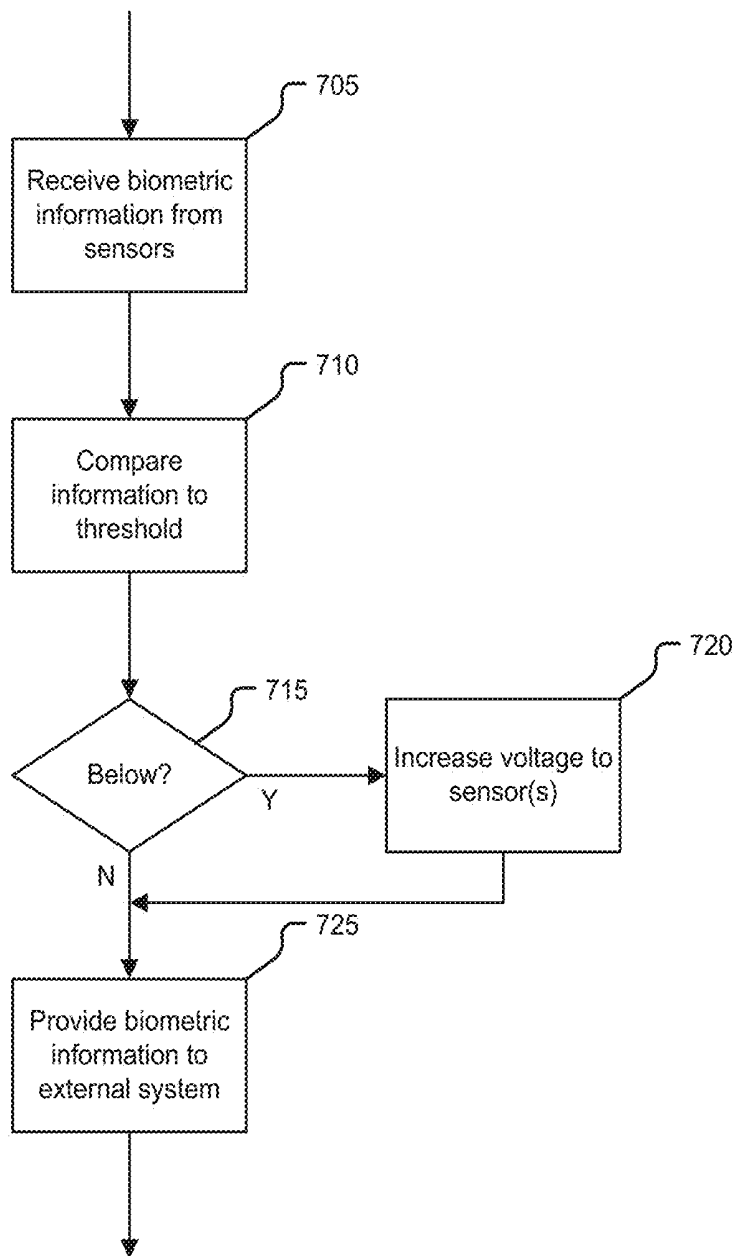


Fig. 7

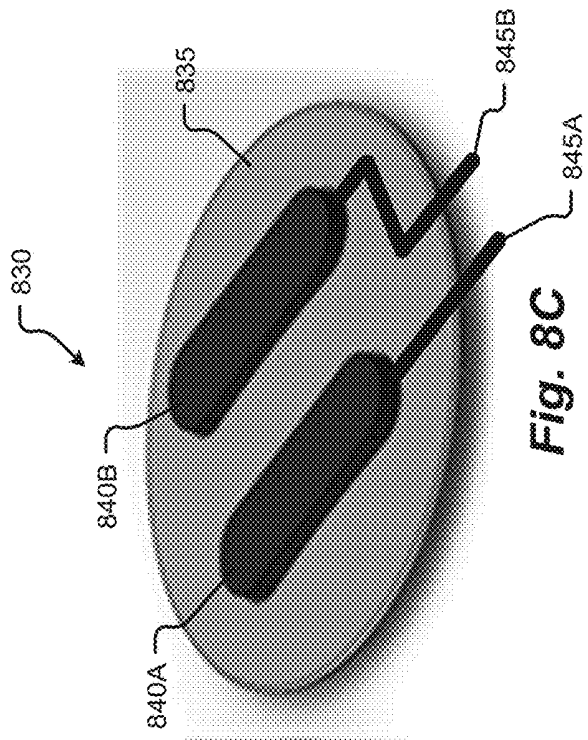


Fig. 8A

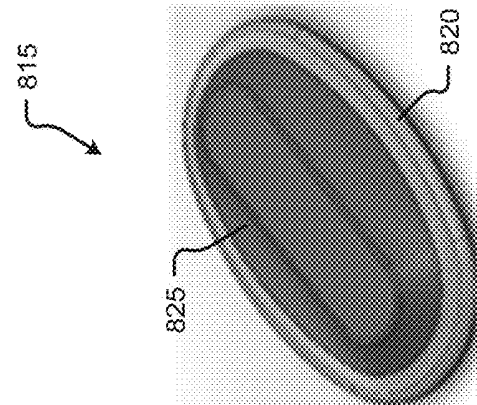


Fig. 8B

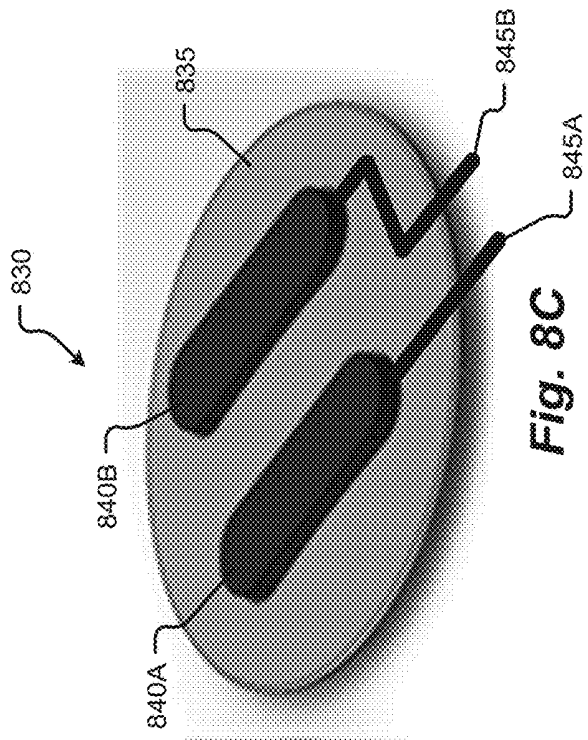


Fig. 8C

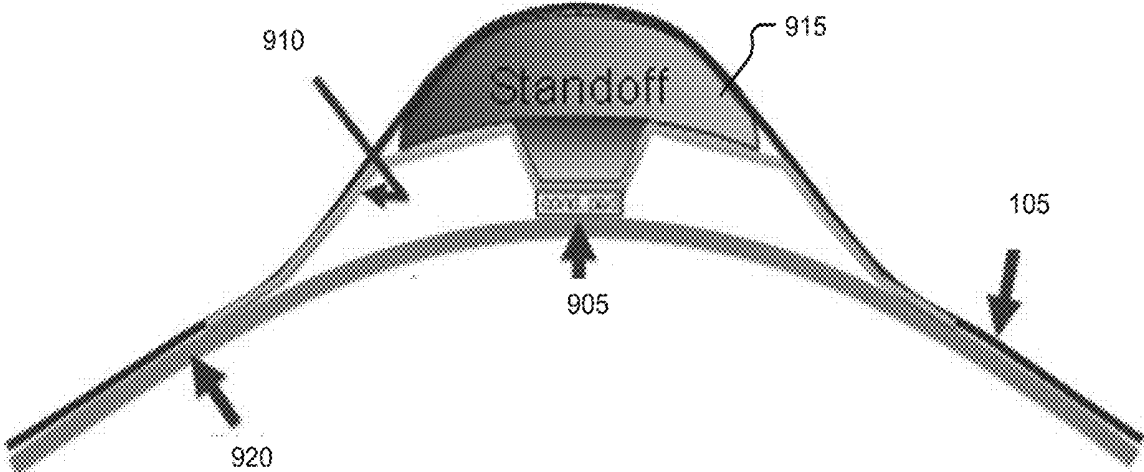


Fig. 9

BIO-SENSING INTEGRATED GARMENT

CROSS REFERENCE TO RELATED APPLICATIONS

[0001] The present application claims the benefits of and priority, under 35 U.S.C. § 119(e), to U.S. Provisional Application No. 62/713,131 filed Aug. 1, 2018 by Mudhafar et al. and entitled “Bio-Sensing Integrated Garment” and U.S. Provisional Application No. 62/713,079 filed Aug. 1, 2018 by Mudhafar et al. and entitled “Garment Integrated Dry Electrode for Vital Signal and Electromyography Sensing.” The entire disclosure of each application listed above is incorporated herein by reference, in its entirety, for all that it teaches and for all purposes.

FIELD OF THE DISCLOSURE

[0002] Embodiments of the present disclosure relate generally to methods and systems for collecting biometric information and more particularly to a garment including integrated sensors for collecting biometric information.

BACKGROUND

[0003] Sensing of vital signs, e.g., heart rate, respiration, temperature, etc., and electromyography, i.e., measurement of muscular activity, and other biometric monitoring are important in a variety of applications ranging from health monitoring of medical patients to performance monitoring of athletes and a combination of performance and health monitoring of military personnel, astronauts, etc. Typically, sensors for performing such monitoring are applied to the monitored person individually at various locations depending on the information monitored. This can be time consuming and tedious if measuring multiple different biometric information. Additionally, such sensors are prone to slippage or dislocation, are susceptible to contamination by dirt and moisture, and may be limiting of the motion of the wearer when the wearer is active. Hence, there is a need in the art for improved systems and methods for collecting biometric information.

BRIEF SUMMARY

[0004] Embodiments of the disclosure provide systems and methods for a garment including integrated sensors for collecting biometric information. According to one embodiment, a bio-sensing garment for collecting biometric information from a wearer of the garment can comprise a fabric layer forming the garment, a plurality of biometric sensors integrated into the fabric layer, and a connectivity layer integrated into the fabric layer. For example, the plurality of biometric sensors can comprise any of an electrocardiography (ECG) sensor, a respiration sensor, a PhotoPlethysmoGram (PPG) sensor, a temperature sensor, and/or an electromyography (EMG) sensor. The fabric layer can comprise a multi-ply construction at least in an area of each of the plurality of biometric sensors and can compress each of the biometric sensors to a skin surface of the wearer of the garment. In some cases, the fabric layer can form a suit covering substantially all of a torso, arms, and legs of the wearer and the fabric layer can comprise one or more stabilizer portions located in each arm sleeve and each leg sleeve.

[0005] The connectivity layer can comprise one or more signal conductors coupled with each of the plurality of

biometric sensors and one or more power conductors coupled with each of the plurality of biometric sensors. The connectivity layer can further comprise a flexible and stretchable substrate of the garment and the signal conductors and power conductors of the connectivity layer can comprise a plurality of traces of conductive ink printed on the flexible and stretchable substrate. The plurality of traces comprises one or more straight-shaped traces and one or more meander-shaped traces. Each sensor of the plurality of biometric sensors can be integrated into the garment and can be connected with the connectivity layer by mechanical clamping and/or the use of a conductive adhesive.

[0006] The garment can further comprise a power source coupled with each of the power conductors and providing, via the power conductors of the connectivity layer, electrical power to each of the plurality of biometric sensors. A signal monitor can be coupled with the connectivity layer and can receive, via the signal conductors of the connectivity layer, a signal comprising biometric information from each of the plurality of biometric sensors. A gateway can be coupled with the signal monitor. The gateway can receive the biometric information from the signal monitor and provide the biometric information to an external computer system. The signal monitor can also be coupled with the power source. In some cases, the signal monitor can compare each received signal comprising biometric information from each of the plurality of biometric sensors to a threshold value corresponding to each sensor. In response to a signal being below the threshold value for the corresponding sensor, a voltage supplied to the corresponding sensor by the power source can be increased.

[0007] According to another embodiment, a signal monitor of a bio-sensing garment can comprise a processor and a memory coupled with and readably by the processor. The memory can store therein a set of instructions which, when executed by the processor, causes the processor to collect biometric information from a wearer of the garment by receiving biometric information from each of a plurality of biometric sensors integrated into a fabric layer of the garment. The plurality of biometric sensors can comprise two or more of an electrocardiography (ECG) sensor, a respiration sensor, a PhotoPlethysmoGram (PPG) sensor, a temperature sensor, and an electromyography (EMG) sensor. The fabric layer can comprise a multi-ply construction at least in an area of each of the plurality of biometric sensors and compresses each of the biometric sensors to a skin surface of the wearer of the garment. In some cases, the fabric layer can form a suit covering substantially all of a torso, arms, and legs of the wearer and can comprise one or more stabilizer portions located in each arm sleeve and each leg sleeve.

[0008] The biometric information can be received via a connectivity layer integrated into the fabric layer of the garment and comprising one or more signal conductors coupled with each of the plurality of biometric sensors and one or more power conductors coupled with each of the plurality of biometric sensors. The connectivity layer can comprise a flexible and stretchable substrate of the garment and the signal conductors and power conductors of the connectivity layer can comprise a plurality of traces of conductive ink printed on the flexible and stretchable substrate with one or more straight-shaped traces and one or more meander-shaped traces. Each sensor of the plurality of biometric sensors can be integrated into the garment and can

be connected with the connectivity layer by mechanical clamping and/or the use of a conductive adhesive.

[0009] The instructions can further cause the processor of the signal monitor to provide the received biometric information to an external computer system via a gateway of the bio-sensing garment. In some cases, the instructions can further cause the processor of the signal monitor to compare each received signal comprising biometric information from each of the plurality of biometric sensors to a threshold value corresponding to each sensor. In response to a signal being below the threshold value for the corresponding sensor, the instructions can cause the processor of the signal monitor to increase a voltage supplied to the corresponding sensor by the power source.

[0010] According to yet another embodiment, a method for collecting biometric information from a wearer of a bio-sensing garment can comprise receiving, by a signal monitor of the bio-sensing garment, biometric information from each of a plurality of biometric sensors integrated into a fabric layer of the garment. The biometric information can be received via a connectivity layer integrated into the fabric layer of the garment and comprising one or more signal conductors coupled with each of the plurality of biometric sensors and one or more power conductors coupled with each of the plurality of biometric sensors. The plurality of biometric sensors can comprise two or more of an electrocardiography (ECG) sensor, a respiration sensor, a PhotoPlethysmoGram (PPG) sensor, a temperature sensor, and an electromyography (EMG) sensor. Each received signal comprising biometric information from each of the plurality of biometric sensors can be compared by the signal monitor of the bio-sensing garment to a threshold value corresponding to each sensor and, in response to a signal being below the threshold value for the corresponding sensor, a voltage supplied to the corresponding sensor by a power source of the bio-sensing garment can be increased. The received biometric information can then be provided by the signal monitor of the bio-sensing garment to an external computer system via a gateway of the bio-sensing garment.

BRIEF DESCRIPTION OF THE DRAWINGS

[0011] FIGS. 1A-1C are diagram illustrating various views of a bio-sensing integrated garment according to one embodiment of the present disclosure.

[0012] FIGS. 2A and 2B illustrate various views of an exemplary biometric sensor according to one embodiment of the present disclosure.

[0013] FIGS. 3A and 3B illustrate various views of an exemplary biometric signal monitor according to one embodiment of the present disclosure.

[0014] FIGS. 4A and 4B illustrate various views of an exemplary gateway for biometric monitoring according to one embodiment of the present disclosure.

[0015] FIG. 5 is a block diagram illustrating exemplary components of a bio-sensing integrated garment according to one embodiment of the present disclosure.

[0016] FIG. 6 is a block diagram illustrating exemplary components of a biometric signal monitor according to one embodiment of the present disclosure.

[0017] FIG. 7 is a flowchart illustrating an exemplary process for monitoring health of an individual wearing a bio-sensing integrated garment according to one embodiment of the present disclosure.

[0018] FIGS. 8A-8C illustrate views of different dry electrode sensor constructions according to various embodiments of the present disclosure.

[0019] FIG. 9 is a cross-sectional view of a dry electrode sensor according to one embodiment of the present disclosure.

[0020] In the appended figures, similar components and/or features may have the same reference label. Further, various components of the same type may be distinguished by following the reference label by a letter that distinguishes among the similar components. If only the first reference label is used in the specification, the description is applicable to any one of the similar components having the same first reference label irrespective of the second reference label.

DETAILED DESCRIPTION

[0021] In the following description, for the purposes of explanation, numerous specific details are set forth in order to provide a thorough understanding of various embodiments disclosed herein. It will be apparent, however, to one skilled in the art that various embodiments of the present disclosure may be practiced without some of these specific details. The ensuing description provides exemplary embodiments only, and is not intended to limit the scope or applicability of the disclosure. Furthermore, to avoid unnecessarily obscuring the present disclosure, the preceding description omits a number of known structures and devices. This omission is not to be construed as a limitation of the scopes of the claims. Rather, the ensuing description of the exemplary embodiments will provide those skilled in the art with an enabling description for implementing an exemplary embodiment. It should however be appreciated that the present disclosure may be practiced in a variety of ways beyond the specific detail set forth herein.

[0022] While the exemplary aspects, embodiments, and/or configurations illustrated herein show the various components of the system collocated, certain components of the system can be located remotely, at distant portions of a distributed network, such as a Local-Area Network (LAN) and/or Wide-Area Network (WAN) such as the Internet, or within a dedicated system. Thus, it should be appreciated, that the components of the system can be combined in to one or more devices or collocated on a particular node of a distributed network, such as an analog and/or digital telecommunications network, a packet-switch network, or a circuit-switched network. It will be appreciated from the following description, and for reasons of computational efficiency, that the components of the system can be arranged at any location within a distributed network of components without affecting the operation of the system.

[0023] Furthermore, it should be appreciated that the various links connecting the elements can be wired or wireless links, or any combination thereof, or any other known or later developed element(s) that is capable of supplying and/or communicating data to and from the connected elements. These wired or wireless links can also be secure links and may be capable of communicating encrypted information. Transmission media used as links, for example, can be any suitable carrier for electrical signals, including coaxial cables, copper wire and fiber optics, and may take the form of acoustic or light waves, such as those generated during radio-wave and infra-red data communications.

[0024] As used herein, the phrases "at least one," "one or more," "or," and "and/or" are open-ended expressions that

are both conjunctive and disjunctive in operation. For example, each of the expressions “at least one of A, B and C,” “at least one of A, B, or C,” “one or more of A, B, and C,” “one or more of A, B, or C,” “A, B, and/or C,” and “A, B, or C” means A alone, B alone, C alone, A and B together, A and C together, B and C together, or A, B and C together.

[0025] The term “a” or “an” entity refers to one or more of that entity. As such, the terms “a” (or “an”), “one or more” and “at least one” can be used interchangeably herein. It is also to be noted that the terms “comprising,” “including,” and “having” can be used interchangeably.

[0026] The term “automatic” and variations thereof, as used herein, refers to any process or operation done without material human input when the process or operation is performed. However, a process or operation can be automatic, even though performance of the process or operation uses material or immaterial human input, if the input is received before performance of the process or operation. Human input is deemed to be material if such input influences how the process or operation will be performed. Human input that consents to the performance of the process or operation is not deemed to be “material.”

[0027] The term “computer-readable medium” as used herein refers to any tangible storage and/or transmission medium that participate in providing instructions to a processor for execution. Such a medium may take many forms, including but not limited to, non-volatile media, volatile media, and transmission media. Non-volatile media includes, for example, Non-Volatile Random-Access Memory (NVRAM), or magnetic or optical disks. Volatile media includes dynamic memory, such as main memory. Common forms of computer-readable media include, for example, a floppy disk, a flexible disk, hard disk, magnetic tape, or any other magnetic medium, magneto-optical medium, a Compact Disk Read-Only Memory (CD-ROM), any other optical medium, punch cards, paper tape, any other physical medium with patterns of holes, a Random-Access Memory (RAM), a Programmable Read-Only Memory (PROM), and Erasable Programmable Read-Only Memory (EPROM), a Flash-EPROM, a solid state medium like a memory card, any other memory chip or cartridge, a carrier wave as described hereinafter, or any other medium from which a computer can read. A digital file attachment to e-mail or other self-contained information archive or set of archives is considered a distribution medium equivalent to a tangible storage medium. When the computer-readable media is configured as a database, it is to be understood that the database may be any type of database, such as relational, hierarchical, object-oriented, and/or the like. Accordingly, the disclosure is considered to include a tangible storage medium or distribution medium and prior art-recognized equivalents and successor media, in which the software implementations of the present disclosure are stored.

[0028] A “computer readable signal” medium may include a propagated data signal with computer readable program code embodied therein, for example, in baseband or as part of a carrier wave. Such a propagated signal may take any of a variety of forms, including, but not limited to, electromagnetic, optical, or any suitable combination thereof. A computer readable signal medium may be any computer readable medium that is not a computer readable storage medium and that can communicate, propagate, or transport a program for use by or in connection with an instruction execution system, apparatus, or device. Program code

embodied on a computer readable medium may be transmitted using any appropriate medium, including but not limited to wireless, wireline, optical fiber cable, Radio Frequency (RF), etc., or any suitable combination of the foregoing.

[0029] The terms “determine,” “calculate,” and “compute,” and variations thereof, as used herein, are used interchangeably and include any type of methodology, process, mathematical operation or technique.

[0030] It shall be understood that the term “means” as used herein shall be given its broadest possible interpretation in accordance with 35 U.S.C., Section 112, Paragraph 6. Accordingly, a claim incorporating the term “means” shall cover all structures, materials, or acts set forth herein, and all of the equivalents thereof. Further, the structures, materials or acts and the equivalents thereof shall include all those described in the summary of the disclosure, brief description of the drawings, detailed description, abstract, and claims themselves.

[0031] Aspects of the present disclosure may take the form of an entirely hardware embodiment, an entirely software embodiment (including firmware, resident software, micro-code, etc.) or an embodiment combining software and hardware aspects that may all generally be referred to herein as a “circuit,” “module” or “system.” Any combination of one or more computer readable medium(s) may be utilized. The computer readable medium may be a computer readable signal medium or a computer readable storage medium.

[0032] In yet another embodiment, the systems and methods of this disclosure can be implemented in conjunction with a special purpose computer, a programmed microprocessor or microcontroller and peripheral integrated circuit element(s), an ASIC or other integrated circuit, a digital signal processor, a hard-wired electronic or logic circuit such as discrete element circuit, a programmable logic device or gate array such as Programmable Logic Device (PLD), Programmable Logic Array (PLA), Field Programmable Gate Array (FPGA), Programmable Array Logic (PAL), special purpose computer, any comparable means, or the like. In general, any device(s) or means capable of implementing the methodology illustrated herein can be used to implement the various aspects of this disclosure. Exemplary hardware that can be used for the disclosed embodiments, configurations, and aspects includes computers, handheld devices, telephones (e.g., cellular, Internet enabled, digital, analog, hybrids, and others), and other hardware known in the art. Some of these devices include processors (e.g., a single or multiple microprocessors), memory, nonvolatile storage, input devices, and output devices. Furthermore, alternative software implementations including, but not limited to, distributed processing or component/object distributed processing, parallel processing, or virtual machine processing can also be constructed to implement the methods described herein.

[0033] Examples of the processors as described herein may include, but are not limited to, at least one of Qualcomm® Snapdragon® 800 and 801, Qualcomm® Snapdragon® 610 and 615 with 4G LTE Integration and 64-bit computing, Apple® A7 processor with 64-bit architecture, Apple® M7 motion coprocessors, Samsung® Exynos® series, the Intel® Core™ family of processors, the Intel® Xeon® family of processors, the Intel® Atom™ family of processors, the Intel Itanium® family of processors, Intel® Core® i5-4670K and i7-4770K 22 nm Haswell, Intel®

Core® i5-3570K 22 nm Ivy Bridge, the AMD® FX™ family of processors, AMD® FX-4300, FX-6300, and FX-8350 32 nm Vishera, AMD® Kaveri processors, Texas Instruments® Jacinto C6000™ automotive infotainment processors, Texas Instruments® OMAP™ automotive-grade mobile processors, ARM® Cortex™-M processors, ARM® Cortex-A and ARM926EJ-S™ processors, other industry-equivalent processors, and may perform computational functions using any known or future-developed standard, instruction set, libraries, and/or architecture.

[0034] In yet another embodiment, the disclosed methods may be readily implemented in conjunction with software using object or object-oriented software development environments that provide portable source code that can be used on a variety of computer or workstation platforms. Alternatively, the disclosed system may be implemented partially or fully in hardware using standard logic circuits or Very Large-Scale Integration (VLSI) design. Whether software or hardware is used to implement the systems in accordance with this disclosure is dependent on the speed and/or efficiency requirements of the system, the particular function, and the particular software or hardware systems or micro-processor or microcomputer systems being utilized.

[0035] In yet another embodiment, the disclosed methods may be partially implemented in software that can be stored on a storage medium, executed on programmed general-purpose computer with the cooperation of a controller and memory, a special purpose computer, a microprocessor, or the like. In these instances, the systems and methods of this disclosure can be implemented as program embedded on personal computer such as an applet, JAVA® or Common Gateway Interface (CGI) script, as a resource residing on a server or computer workstation, as a routine embedded in a dedicated measurement system, system component, or the like. The system can also be implemented by physically incorporating the system and/or method into a software and/or hardware system.

[0036] Although the present disclosure describes components and functions implemented in the aspects, embodiments, and/or configurations with reference to particular standards and protocols, the aspects, embodiments, and/or configurations are not limited to such standards and protocols. Other similar standards and protocols not mentioned herein are in existence and are considered to be included in the present disclosure. Moreover, the standards and protocols mentioned herein and other similar standards and protocols not mentioned herein are periodically superseded by faster or more effective equivalents having essentially the same functions. Such replacement standards and protocols having the same functions are considered equivalents included in the present disclosure.

[0037] Various additional details of embodiments of the present disclosure will be described below with reference to the figures. While the flowcharts will be discussed and illustrated in relation to a particular sequence of events, it should be appreciated that changes, additions, and omissions to this sequence can occur without materially affecting the operation of the disclosed embodiments, configuration, and aspects.

[0038] Embodiments of the disclosure provide systems and methods for a garment including integrated sensors for collecting biometric information. Generally speaking, and as will be described in greater detail below, to monitor health and muscular activities, a garment equipped with bio-sen-

sors could be worn by a person whose health requires a continuous monitoring. Such garment could be equipped with bio-sensors that monitors vital signals such as ECG, respiration, PPG, blood pressure, core body temperature, as well as muscular activities like EMG. These sensors can be located within the garment and on the body of the wearer of the garment to monitor electrical signals as well as by other sensing means like optically or thermally. The signals generated by these sensors can be gathered and processed by electronic circuits that are interconnected via a web of connectivity layer integrated in the garment. These interconnected sensors and circuits can be so integrated into the garment that the interference with the person's normal activities is minimal. Electrical power for the bio-sensing system could be provided by a portable source within, on, or near the garment or by using energy harvesting means similarly situated within, on, or near the garment. The monitoring data can be transmitted on wire or wireless communications connection to a computing node for further analysis and alarm generation as appropriate.

[0039] FIGS. 1A-1C are diagram illustrating various views of a bio-sensing integrated garment according to one embodiment of the present disclosure. More specifically, FIG. 1A illustrates a front view of a bio-sensing integrated garment **100** as described herein. As illustrated in this example, the bio-sensing integrated garment **100** can comprise a fabric layer **105** forming a suit substantially covering the torso, arms, and legs of the wearer. A number of sensors **110A-110E** can be seen in this view. These sensors **110A-110E** can be connected with a connectivity layer **115** of the garment. The sensors **110A-110E** and other elements of the garment as will be described can be by using conductive ink printed in a flexible and stretchable substrate such as TPU bonded to the fabric layer **105** of the garment **100**. The sensors **110A-110E** can include, but are not limited to, an ECG sensor which can consist of electrodes, printed connectivity traces, electronic circuits for digitization of the ECG signal, a respiration sensor which can consist of electrodes for bio-impedance measurement, electronics circuits, printed connectivity traces, a PPG sensor which can consist of an optical sensor (itself consists of a number of LEDs and Photo Detectors), and electronic circuit that drives the optical sensor, a temperature sensor and printed connectivity traces, an EMG sensor which can consist of pairs of electrodes, printed connectivity traces, and electronic circuit for digitization of the analog signal, and/or other sensors for collecting biometric information from the wearer of the bio-sensing integrated garment **100**.

[0040] FIG. 1B illustrates a side view of the bio-sensing integrated garment **100** while FIG. 1C illustrates a back view of the bio-sensing integrated garment **100**. In each of these views, additional sensors **110F-110I** can be seen in different locations for measuring different biometric information. Additionally, a signal monitor **125** can be seen. Generally speaking, and as will be described in greater detail below, the signal monitor **125** can receive the biometric information from the various sensors **110A-110I** and provide that information to an external computer system (not shown here) for monitoring. In some cases, the bio-sensing integrated garment **100** may include one or more electrical connectors that may provide wired access to the external computer system and/or provide electrical power to the sensors **110A-110I**, signal monitor and other elements of the bio-sensing integrated garment **100**. Additionally, or alternatively, the signal

monitor **125** of the bio-sensing integrated garment **100** may utilize one or more wireless communications transmitters to provide the biometric information to the external computer system.

[0041] The electronic circuits for the sensors **110A-110I** can be interconnected via the connectivity layer (not shown here) which can comprise a web of traces printed on a stretchable and bio-compatible substrate, such as TPU, using conductive ink. This substrate can be bound to the fabric layer of the bio-sensing integrated garment **100**. These traces could be made in different conductive ink with different geometries including straight shapes as well as meander shapes so as to achieve the minimum resistance under stretch conduction while maintaining the smallest dimensions. Some of these traces can constitute power lines that provide electrical power to the bio-sensing electronics dispersed all over the garment. In order to mitigate the excessive path resistance, increase due to stretching, the signal monitor **125** may boost the voltage from one bio-sensing node to the other. The boosting is decided by software based on need; i.e. whether the voltage has gone below a threshold. These webs of connectivity can carry high speed digital signals implementing a communication protocol for handling the data transport from the data collection sites, i.e., the electronic circuits of the sensors, to a gateway that funnel all the data stream to the external data analysis compute system outside the garment. The gateway could be connecting to the outside compute system via wire or wireless means.

[0042] FIGS. 2A and 2B illustrate various views of an exemplary biometric sensor according to one embodiment of the present disclosure. More specifically, FIG. 2A illustrates an exploded view of the exemplary biometric sensor **200** while FIG. 2B illustrates an assembled view of the biometric sensor **200**. As illustrated here, the biometric sensor **200** can be constructed of an inner housing **205** and inner seal gasket **210** to prevent dirt and moisture contamination inside of the assembled sensor **200**. The inner housing **205** and inner seal gasket can be affixed to a Gilford **215** of pre-cut backing material via a PET stiffener **220**. A TPU web **235** can be disposed adjacent to the Gilford **215**. The TPU web **235** can have affixed thereto a set of electrodes **230** and can include a number of conductive traces to the electrodes **230**. A printed circuit board **225** of the sensor **200** including electronic circuits as known in the art based on the sensor type may be mounted onto the TPU web **235** and a TPU encapsulation layer **240** may be disposed on top of the TPU web **235**. Finally, an outer seal gasket **245** and outer housing **250** may be affixed to the sensor **200** to complete enclosure of the printed circuit board **225**.

[0043] The integration of the sensor **200** with the garment can be carried out in way that the connection between the printed circuit board **225** pinout and the printed connectivity traces on the TPU web **235** can be realized by a mechanical clamping of the inner housing **205**, PET stiffener **220**, and outer housing **250** as well as other means such as by using conductive adhesive. The integration of the sensor **200** into the garment in this way, together with the inner seal gasket **210** and outer seal gasket **245** provides a tight seal so as to prevent any water or contaminant leakage.

[0044] FIGS. 3A and 3B illustrate various views of an exemplary biometric signal monitor according to one embodiment of the present disclosure. More specifically, FIG. 3A illustrates an exploded view of the exemplary biometric signal monitor **300** while FIG. 3B illustrates an

assembled view of the biometric signal monitor **300**. As illustrated here, the biometric signal monitor **300** can be constructed of an outer housing **305** and outer seal gasket **310** to prevent dirt and moisture contamination inside of the assembled biometric signal monitor **300**. The outer housing **305** and outer seal gasket **310** can be affixed to a Gilford **315** of pre-cut backing material via a PET stiffener **320**. A TPU web **325** can be disposed adjacent to the Gilford **315**. The TPU web **325** can have a number of conductive traces to the connectivity layer described herein. A printed circuit board **330** of the biometric signal monitor **300** including electronic circuits for receiving, processing, and uploading or transmitting biometric information as described herein mounted onto the TPU web **325**. Finally, an inner seal gasket **335**, inner housing **340**, and cover **345** may be affixed to the biometric signal monitor **300** to complete enclosure of the printed circuit board **330**.

[0045] FIGS. 4A and 4B illustrate various views of an exemplary gateway for biometric monitoring according to one embodiment of the present disclosure. More specifically, FIG. 4A illustrates an exploded view of the exemplary gateway **400** while FIG. 4B illustrates an assembled view of the gateway **400**. As illustrated here, the gateway **400** can be constructed of an inner housing **405** and inner seal gasket **410** to prevent dirt and moisture contamination inside of the assembled gateway **400**. A printed circuit board **415** of the gateway **400** including electronic circuits as known in the art for transmitting biometric information to an external computer may be mounted onto or within the inner housing **405**. A TPU web **420** can be disposed adjacent to the inner housing **405** and inner seal gasket **410**. A PET stiffener **425** may be disposed adjacent to the TPU web **420** and a Gilford **215** of pre-cut backing material may be disposed next to and affixed to the PET stiffener **425** and TPU web **420**. Finally, an outer seal gasket **435** and outer housing **440** may be affixed to the gateway **400** to complete enclosure of the printed circuit board **415**. In some cases, a strain relief device **445**, such as a spring and/or lever maybe affixed to the outer housing **440**.

[0046] FIG. 5 is a block diagram illustrating exemplary components of a bio-sensing integrated garment according to one embodiment of the present disclosure. As illustrated in this example, a bio-sensing garment **100** for collecting biometric information from a wearer of the garment can comprise a fabric layer **105** forming the garment, a plurality of biometric sensors **110A-110D** integrated into the fabric layer **105**, and a connectivity layer **115** integrated into the fabric layer **105** as introduced above. For example, the plurality of biometric sensors **110A-110D** can comprise any of an electrocardiography (ECG) sensor, a respiration sensor, a PhotoPlethysmoGram (PPG) sensor, a temperature sensor, and/or an electromyography (EMG) sensor. The fabric layer **105** can comprise a multi-ply construction at least in an area of each of the plurality of biometric sensors **110A-110D** and can compress each of the biometric sensors **110A-110D** to a skin surface of the wearer of the garment **100**. In some cases, the fabric layer **105** can form a suit covering substantially all of a torso, arms, and legs of the wearer and the fabric layer can comprise one or more stabilizer portions, e.g., rings, bands, or other structures providing additional compression and/or non-slip surfaces located in each arm sleeve and each leg sleeve to prevent the arm and/or legs sleeves from slipping, riding up or down, rotating, etc.

[0047] The connectivity layer 115 can comprise one or more signal conductors 515A coupled with each of the plurality of biometric sensors 110A-110D and one or more power conductors 515B coupled with each of the plurality of biometric sensors. The connectivity layer 115 can further comprise a flexible and stretchable substrate of the garment and the signal conductors 515A and power conductors 515B of the connectivity layer 115 can comprise a plurality of traces of conductive ink printed on the flexible and stretchable substrate. The plurality of traces can comprise one or more straight-shaped traces and one or more meander-shaped traces. Each sensor of the plurality of biometric sensors 110A-110D can be integrated into the garment 100 and can be connected with the connectivity layer 115 by mechanical clamping and/or the use of a conductive adhesive.

[0048] The garment 100 can further comprise a power source 510 coupled with each of the power conductors 515B and providing, via the power conductors 515B of the connectivity layer 115, electrical power to each of the plurality of biometric sensors 110A-110D. A signal monitor 125 can be coupled with the connectivity layer 115 and can receive, via the signal conductors 515A of the connectivity layer 115, a signal comprising biometric information from each of the plurality of biometric sensors 110A-110D. A gateway 505 can be coupled with the signal monitor 125. The gateway 505 can receive the biometric information from the signal monitor 125 and provide the biometric information to an external computer system. The signal monitor 125 can also be coupled with the power source 510. In some cases, the signal monitor 125 can compare each received signal comprising biometric information from each of the plurality of biometric sensors 110A-110D to a threshold value corresponding to each sensor. In response to a signal being below the threshold value for the corresponding sensor, a voltage supplied to the corresponding sensor by the power source can be increased.

[0049] FIG. 6 is a block diagram illustrating exemplary components of a biometric signal monitor according to one embodiment of the present disclosure. As illustrated in this example, a signal monitor 125 of a bio-sensing garment 100 can comprise a processor 605 and a memory 610 coupled with and readable by the processor 605 via a communication bus 615. The memory 610 can store therein a set of instructions which, when executed by the processor 605, causes the processor 605 to collect biometric information from a wearer of the garment 100. For example, the memory 610 can store therein a set of sensor reading instructions 625 which, when executed by the processor 605, can cause the processor 605 to receive biometric information from each of a plurality of biometric sensors 110A-110I integrated into a fabric layer 105 of the garment 100. The plurality of biometric sensors 110A-110I can comprise two or more of an electrocardiography (ECG) sensor, a respiration sensor, a PhotoPlethysmoGram (PPG) sensor, a temperature sensor, and an electromyography (EMG) sensor. The fabric layer 105 can comprise a multi-ply construction at least in an area of each of the plurality of biometric sensors 110A-110I and compresses each of the biometric sensors 110A-110I to a skin surface of the wearer of the garment 100. In some cases, the fabric layer 105 can form a suit covering substantially all of a torso, arms, and legs of the wearer and can comprise one or more stabilizer portions located in each arm sleeve and each leg sleeve.

[0050] As described above, the biometric information can be received via a connectivity layer 115 integrated into the fabric layer 105 of the garment 100 and comprising one or more signal conductors 515A coupled with each of the plurality of biometric sensors 110A-110I and one or more power conductors 515B coupled with each of the plurality of biometric sensors 110A-110I. The signal monitor 125 can include one or more communication interfaces 620 providing a connection to the signal conductors 515A of the connectivity layer 115 to allow the processor 605 to receive the biometric information from the plurality of biometric sensors 110A-110I.

[0051] The memory 610 can also store a set of uploading instructions 630 which, when executed by the processor 605, can further cause the processor 605 of the signal monitor 125 to provide the received biometric information to an external computer system via a gateway 505 of the bio-sensing garment 100 as described above. In some cases, the memory 610 may also store a set of power adjustment instructions 635 which, when executed by the processor 605, can further cause the processor 605 of the signal monitor 125 to compare each received voltage on the power traces to a threshold value corresponding to each sensor. In response to a voltage being below the threshold value for the corresponding sensor, the power adjustment instructions 635 can cause the processor 605 of the signal monitor 125 to increase a voltage supplied to the corresponding sensor by the power source 510.

[0052] FIG. 7 is a flowchart illustrating an exemplary process for monitoring health of an individual wearing a bio-sensing integrated garment according to one embodiment of the present disclosure. As illustrated in this example, collecting biometric information from a wearer of a bio-sensing garment can comprise receiving 705, by a signal monitor of the bio-sensing garment, biometric information from each of a plurality of biometric sensors integrated into a fabric layer of the garment. The biometric information can be received 705 via a connectivity layer integrated into the fabric layer of the garment and comprising one or more signal conductors coupled with each of the plurality of biometric sensors and one or more power conductors coupled with each of the plurality of biometric sensors. The plurality of biometric sensors can comprise two or more of an electrocardiography (ECG) sensor, a respiration sensor, a PhotoPlethysmoGram (PPG) sensor, a temperature sensor, and an electromyography (EMG) sensor.

[0053] In some cases, each received voltage on the power traces can be compared 710 to a threshold value corresponding to each sensor and a determination 715 can be made as to whether the received voltage is below the threshold. In response to determining 715 a signal being below the threshold value for the corresponding sensor, a voltage supplied to the corresponding sensor by a power source of the bio-sensing garment can be increased 720. The received biometric information can then be provided 725 by the signal monitor of the bio-sensing garment to an external computer system via a gateway of the bio-sensing garment.

[0054] To monitor health and muscular activities, a garment 100 such as described herein equipped with bio-sensors 110A-110I could be worn by a person whose health requires a continuous monitoring. Such garment could employ electrodes to track heart, respiration as well as muscular activities. These electrodes should be textile-integratable, capable of reliably picking up the vital or EMG

signals from the body, motion-resistant, cleanable, scalable, soft, unperceivable, and minimally interfering with the user's normal activities. The traditional wet-electrodes are not suitable to garment integration as they do not fulfil the above requirements. According to one embodiment, biosensors 110A-110I for integration into a garment 100 as described herein can comprise a dry electrode sensor consisting of a conductive pad area, connectivity traces, and a backing.

[0055] FIGS. 8A-8C illustrate views of different dry electrode sensor constructions according to various embodiments of the present disclosure. More specifically, FIG. 8A illustrates a sensor 800 comprising a backing 805 and two conductive pads 810A and 810B which are the electrodes of the sensor 800. FIG. 8B illustrates a sensor 810 comprising a backing 820 and a single conductive pad 825. FIG. 8C illustrates a sensor 830 comprising a backing 835, two conductive pads 840A and 840B and a set of connectivity traces 845A and 845B.

[0056] Regardless of the exact configuration, both the conductive pad area and the connectivity traces can be printed using conductive ink, which is stretchable and washable. The printing can be performed over a substrate that is stretchable and washable such as TPU. To enhance the contact with the skin, the printing of the conductive pad could be textured in different patterns.

[0057] FIG. 9 is a cross-sectional view of a dry electrode sensor according to one embodiment of the present disclosure. As illustrated in this example, a dry electrode biosensor 830 can comprise one or more conductive pads 905 comprising electrodes of the dry electrode biosensor 830 and one or more connectivity traces 845A and 845B coupled with each of the one or more conductive pads 905. The connectivity traces 845A and 845B can provide electrical connections for one or more power to the one or more conductive pads 905 or signals comprising biometric information from the one or more conductive pads 905. A backing 910 can be coupled with and can retain the one or more conductive pads 905 and the one or more connectivity traces 845A and 845B. The dry electrode biosensor 830 can comprise an electrocardiography (ECG) sensor, a respiration sensor, a PhotoPlethysmoGram (PPG) sensor, a temperature sensor, an electromyography (EMG) sensor, or another biometric sensor.

[0058] The one or more conductive pads 905 and the one or more connectivity traces 845A and 845B can be printed in stretchable and washable conductive ink. In some cases, the one or more conductive pads 905 and one or more connectivity traces 845A and 845B can be printed on a stretchable and washable substrate. A surface of each of the one or more conductive pads placed against a wearer's skin 920 when the dry electrode biosensor 830 is in use can be textured.

[0059] A standoff 915 can be disposed on a side of the backing 910 opposite from the one or more conductive pads 905, the standoff 915 transferring pressure to the one or more conductive pads 905 when the conductive pads 905 are applied to a skin 920 of a wearer of the dry-electrode biosensor 830. The standoff 915 can be constructed of a flexible material. The pressure transferred by the standoff 915 to the one or more conductive pads 905 can be applied by a compressive textile, e.g., the fabric layer 105 of the garment 100. The shape of the standoff 915 on a portion

adjacent to the compressive textile can have a more curvature than a portion adjacent to the one or more conductive pads 905.

[0060] Thus, the electrode has a conductive pad 905 area that interfaces with the skin 920 from which the bio signals are picked up. Note that the conduction pad 905 could be printed on a lamination layer that adheres to the fabric as well as to the standoff 915. The performance of the signal pick-up is a function of the compression exerted on the conductive pad 905 against the skin 920; i.e. the higher the compression the better the signal pick-up. The compression can be attained by having a compressive textile pushing down on the electrode back, i.e., the standoff 915. The compression value applied by the fabric layer 105 is function of the standoff 915 shape.

[0061] According to one embodiment, the construction of the standoff 905 could be based on foamy, flexible or rigid materials so as to comply to the skin curvature and thus to provide a more reliable skin contact. The pressure on the conductive pads 905 emanates from the use of compressive textile the wraps around the body part and carries the electrodes. The pressure can be increased by shaping the back of the standoff 915, i.e., the sides that faces the compressive fabric layer 105, so that its curvature is a lot smaller than the body curvature where the electrode is located. The law that governs that the pressure is Laplace's law:

$$P_1 = \frac{T}{R}$$

[0062] Where P_1 is the pressure applied on the back of the standoff, R is the radius of the curvature of the standoff, T is the tension (N/cm) from the textile due to stretching defined as:

$$T = \frac{F}{W} \cdot \frac{\epsilon}{\epsilon_0}$$

[0063] Where F is the force applied to a reference sample of width W (cm) that stretched ϵ_0 (mm), and ϵ (mm) is the stretch of the garment wrapped around a part of the body (like arm, leg, or torso).

[0064] Also, the area reduction of the area of the back of the standoff with respect to the area of the conductive pad:

$$P_2 = P_1 \frac{A_{standoff\ back}}{A_{conductive\ pad\ area}}$$

[0065] The present disclosure, in various aspects, embodiments, and/or configurations, includes components, methods, processes, systems, and/or apparatus substantially as depicted and described herein, including various aspects, embodiments, configurations, sub-combinations, and/or subsets thereof. Those of skill in the art will understand how to make and use the disclosed aspects, embodiments, and/or configurations after understanding the present disclosure. The present disclosure, in various aspects, embodiments, and/or configurations, includes pro-

viding devices and processes in the absence of items not depicted and/or described herein or in various aspects, embodiments, and/or configurations hereof, including in the absence of such items as may have been used in previous devices or processes, e.g., for improving performance, achieving ease and/or reducing cost of implementation.

[0066] The foregoing discussion has been presented for purposes of illustration and description. The foregoing is not intended to limit the disclosure to the form or forms disclosed herein. In the foregoing Detailed Description for example, various features of the disclosure are grouped together in one or more aspects, embodiments, and/or configurations for the purpose of streamlining the disclosure. The features of the aspects, embodiments, and/or configurations of the disclosure may be combined in alternate aspects, embodiments, and/or configurations other than those discussed above. This method of disclosure is not to be interpreted as reflecting an intention that the claims require more features than are expressly recited in each claim. Rather, as the following claims reflect, inventive aspects lie in less than all features of a single foregoing disclosed aspect, embodiment, and/or configuration. Thus, the following claims are hereby incorporated into this Detailed Description, with each claim standing on its own as a separate preferred embodiment of the disclosure.

[0067] Moreover, though the description has included description of one or more aspects, embodiments, and/or configurations and certain variations and modifications, other variations, combinations, and modifications are within the scope of the disclosure, e.g., as may be within the skill and knowledge of those in the art, after understanding the present disclosure. It is intended to obtain rights which include alternative aspects, embodiments, and/or configurations to the extent permitted, including alternate, interchangeable and/or equivalent structures, functions, ranges or steps to those claimed, whether or not such alternate, interchangeable and/or equivalent structures, functions, ranges or steps are disclosed herein, and without intending to publicly dedicate any patentable subject matter.

What is claimed is:

1. A bio-sensing garment for collecting biometric information from a wearer of the garment, the garment comprising:

- a fabric layer forming the garment;
- a plurality of biometric sensors integrated into the fabric layer;
- a connectivity layer integrated into the fabric layer and comprising one or more signal conductors coupled with each of the plurality of biometric sensors and one or more power conductors coupled with each of the plurality of biometric sensors;
- a power source coupled with each of the power conductors and providing, via the power conductors of the connectivity layer, electrical power to each of the plurality of biometric sensors;
- a signal monitor coupled with the connectivity layer and receiving, via the signal conductors of the connectivity layer, a signal comprising biometric information from each of the plurality of biometric sensors; and
- a gateway coupled with the signal monitor, the gateway receiving the biometric information from the signal monitor and providing the biometric information to an external computer system.

2. The bio-sensing garment of claim 1, wherein the connectivity layer comprises a flexible and stretchable substrate of the garment and wherein the signal conductors and power conductors of the connectivity layer comprise a plurality of traces of conductive ink printed on the flexible and stretchable substrate.

3. The bio-sensing garment of claim 2, wherein the plurality of traces comprise one or more straight-shaped traces and one or more meander-shaped traces.

4. The bio-sensing garment of claim 1, wherein the plurality of biometric sensors comprises at least one electrocardiography (ECG) sensor.

5. The bio-sensing garment of claim 1, wherein the plurality of biometric sensors comprises at least one respiration sensor.

6. The bio-sensing garment of claim 1, wherein the plurality of biometric sensors comprises at least one PhotoPlethysmoGram (PPG) sensor.

7. The bio-sensing garment of claim 1, wherein the plurality of biometric sensors comprises at least one temperature sensor.

8. The bio-sensing garment of claim 1, wherein the plurality of biometric sensors comprises at least one electromyography (EMG) sensor.

9. The bio-sensing garment of claim 1, wherein the signal monitor is further coupled with the power source and wherein the signal monitor further compares each received voltage on the power the traces to a threshold value corresponding to each sensor and, in response to the power is being below a threshold value for the corresponding sensor, increasing a voltage supplied to the corresponding sensor by the power source.

10. The bio-sensing garment of claim 1, wherein each sensor of the plurality of biometric sensors is integrated into the garment and is connected with the connectivity layer by mechanical clamping and/or the use of a conductive adhesive.

11. The bio-sensing garment of claim 1, wherein the fabric layer comprises a multi-ply construction at least in an area of each of the plurality of biometric sensors and compresses each of the biometric sensors to a skin surface of the wearer of the garment.

12. The bio-sensing garment of claim 1, wherein the fabric layer forms a suit covering substantially all of a torso, arms, and legs of the wearer and wherein the fabric layer comprises one or more stabilizer portions located in each arm sleeve and each leg sleeve.

13. A signal monitor of a bio-sensing garment, the signal monitor comprising:

- a processor; and
- a memory coupled with and readably by the processor and storing therein a set of instructions which, when executed by the processor, causes the processor to collect biometric information from a wearer of the garment by:
 - receiving biometric information from each of a plurality of biometric sensors integrated into a fabric layer of the garment, the biometric information received via a connectivity layer integrated into the fabric layer of the garment and comprising one or more signal conductors coupled with each of the plurality of biometric sensors and one or more power conductors coupled with each of the plurality of biometric sensors, and

- providing the received biometric information to an external computer system via a gateway of the bio-sensing garment.
- 14.** The signal monitor of claim **13**, wherein the connectivity layer comprises a flexible and stretchable substrate of the garment and wherein the signal conductors and power conductors of the connectivity layer comprise a plurality of traces of conductive ink printed on the flexible and stretchable substrate and wherein the plurality of traces comprise one or more straight-shaped traces and one or more meander-shaped traces.
- 15.** The signal monitor of claim **13**, wherein the plurality of biometric sensors comprises two or more of an electrocardiography (ECG) sensor, a respiration sensor, a PhotoPlethysmoGram (PPG) sensor, a temperature sensor, and an electromyography (EMG) sensor.
- 16.** The signal monitor of claim **13**, wherein the signal monitor is further coupled with a power source for the plurality of biometric sensors and wherein the signal monitor further compares each received signal comprising biometric information from each of the plurality of biometric sensors to a threshold value corresponding to each sensor and, in response to a signal being below the threshold value for the corresponding sensor, increasing a voltage supplied to the corresponding sensor by the power source.
- 17.** The signal monitor of claim **13**, wherein each sensor of the plurality of biometric sensors is integrated into the garment and is connected with the connectivity layer by mechanical clamping and/or the use of a conductive adhesive.
- 18.** The signal monitor of claim **13**, wherein the fabric layer comprises a multi-ply construction at least in an area of each of the plurality of biometric sensors and compresses each of the biometric sensors to a skin surface of the wearer of the garment.
- 19.** The signal monitor of claim **13**, wherein the fabric layer forms a suit covering substantially all of a torso, arms, and legs of the wearer and wherein the fabric layer comprises one or more stabilizer portions located in each arm sleeve and each leg sleeve.
- 20.** A method for collecting biometric information from a wearer of a bio-sensing garment, the method comprising:
- receiving, by a signal monitor of the bio-sensing garment, biometric information from each of a plurality of biometric sensors integrated into a fabric layer of the garment, the biometric information received via a connectivity layer integrated into the fabric layer of the garment and comprising one or more signal conductors coupled with each of the plurality of biometric sensors and one or more power conductors coupled with each of the plurality of biometric sensors, wherein the plurality of biometric sensors comprises two or more of an electrocardiography (ECG) sensor, a respiration sensor, a PhotoPlethysmoGram (PPG) sensor, a temperature sensor, and an electromyography (EMG) sensor;
 - comparing, by the signal monitor of the bio-sensing garment, each received voltage on the power traces to a threshold value corresponding to each sensor and, in response to power being below the threshold value for the corresponding sensor, increasing a voltage supplied to the corresponding sensor by a power source of the bio-sensing garment; and
 - providing, by the signal monitor of the bio-sensing garment, the received biometric information to an external computer system via a gateway of the bio-sensing garment.

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摘要(译)

本公开的实施例提供了用于服装的系统和方法，该服装包括织物层，集成到织物层中的多个生物识别传感器以及集成到织物层中的连接层。连接层可以包括与多个生物统计传感器中的每一个耦接的信号导体和电力导体。该服装还可包括电源，该电源与每个电源导体耦合并且经由连接层的电源导体向多个生物识别传感器中的每个生物传感器提供电功率，信号监视器与连接层耦合并且经由该连接器接收连接层的信号导体，包括来自多个生物特征传感器中的每个生物特征传感器的生物特征信息的信号，以及与信号监视器耦合的网关，该网关从信号监视器接收生物特征信息并将生物特征信息提供给外部计算机系统。

